

To our customers,

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## Old Company Name in Catalogs and Other Documents

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April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

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# MOS FIELD EFFECT TRANSISTOR 2SJ690

## P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

### DESCRIPTION

The 2SJ690 is a P-channel MOSFET designed for power switch of portable machine and so on.

### FEATURES

- 2.5 V drive available
- Low on-state resistance  
 $R_{DS(on)1} = 119 \text{ m}\Omega \text{ MAX. (} V_{GS} = -4.5 \text{ V, } I_D = -1.0 \text{ A)}$   
 $R_{DS(on)2} = 217 \text{ m}\Omega \text{ MAX. (} V_{GS} = -2.5 \text{ V, } I_D = -1.0 \text{ A)}$
- Built-in gate protection diode

### ORDERING INFORMATION

PART NUMBER	PACKAGE
2SJ690-T1B-AT	SC-96 (Mini Mold Thin Type)

**Remark** "-AT" indicates Pb-free (This product does not contain Pb in external electrode and other parts.)

"-T1B" indicates the unit orientation.

(8 mm embossed carrier tape, 3000 pcs/reel)

**Marking:** XT

### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Drain to Source Voltage (V <sub>GS</sub> = 0 V)	V <sub>DSS</sub>	-30	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	V <sub>GSS</sub>	±12	V
Drain Current (DC)	I <sub>D(DC)</sub>	±2.5	A
Drain Current (pulse) <sup>Note1</sup>	I <sub>D(pulse)</sub>	±10	A
Total Power Dissipation	P <sub>T1</sub>	0.2	W
Total Power Dissipation <sup>Note2</sup>	P <sub>T2</sub>	1.25	W
Channel Temperature	T <sub>ch</sub>	150	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

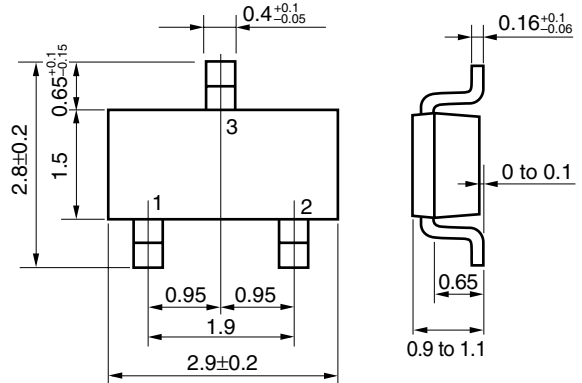
**Notes** 1. PW ≤ 10 μs, Duty Cycle ≤ 1 %

2. Mounted on FR-4 board, t ≤ 5 sec.

**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

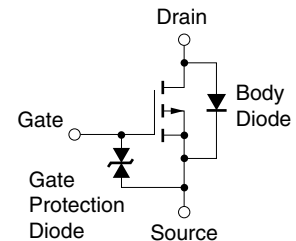
**Caution** This product is electrostatic-sensitive device due to low ESD capability and should be handled with caution for electrostatic discharge.

### PACKAGE DRAWING (Unit : mm)



1: Gate  
2: Source  
3: Drain

### EQUIVALENT CIRCUIT



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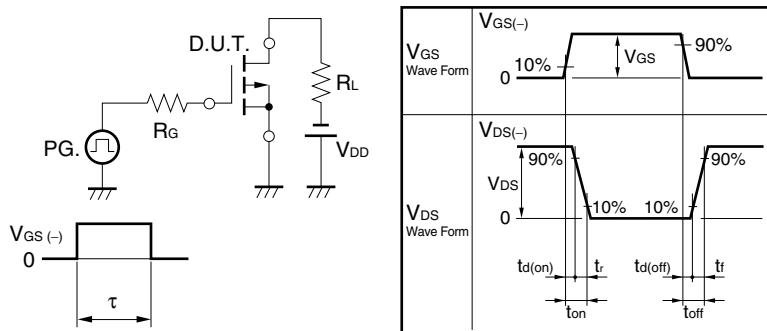
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**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)**

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Cut-off Current	I <sub>DSS</sub>	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V			-1	μA
Gate Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±12 V, V <sub>DS</sub> = 0 V			±10	μA
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1.0 mA	-0.5		-1.5	V
Forward Transfer Admittance <sup>Note</sup>	y <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1.0 A	2.0			S
Drain to Source On-state Resistance <sup>Note</sup>	R <sub>DS(on)1</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -1.0 A		87	119	mΩ
	R <sub>DS(on)2</sub>	V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -1.0 A		120	217	mΩ
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -10 V,		450		pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V,		80		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz		64		pF
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = -15 V, I <sub>D</sub> = -1.0 A,		12		ns
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = -4.5 V,		5		ns
Turn-off Delay Time	t <sub>d(off)</sub>	R <sub>G</sub> = 10 Ω		38		ns
Fall Time	t <sub>f</sub>			29		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = -24 V,		5.2		nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = -4.5 V,		1.1		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = -2.5 A		2.3		nC
Diode Forward Voltage <sup>Note</sup>	V <sub>F(S-D)</sub>	I <sub>F</sub> = -2.5 A, V <sub>GS</sub> = 0 V		0.9		V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = -2.5 A, V <sub>GS</sub> = 0 V,		37		ns
Reverse Recovery Charge	Q <sub>rr</sub>	di/dt = -50 A/μs		14		nC

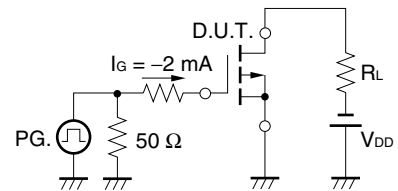
**Note** Pulsed

**TEST CIRCUIT 1 SWITCHING TIME**



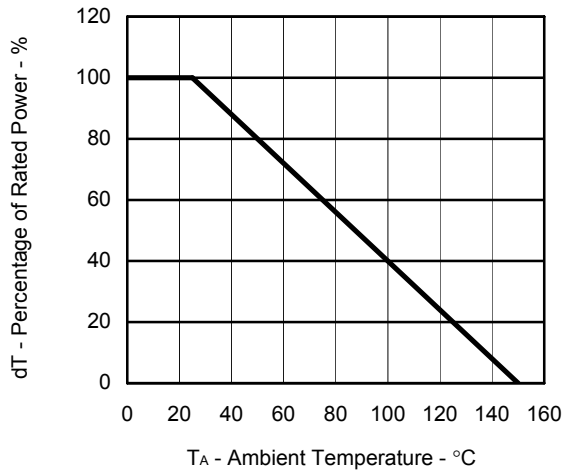
τ = 1 μs  
Duty Cycle ≤ 1%

**TEST CIRCUIT 2 GATE CHARGE**

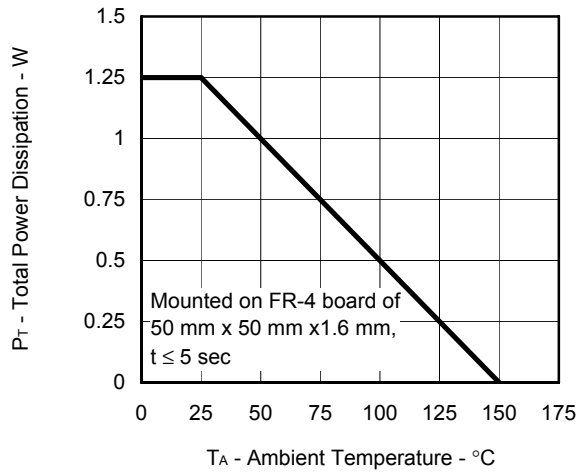


TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)

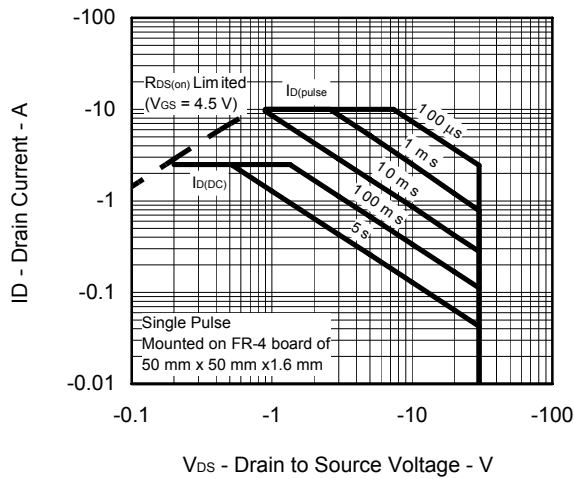
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



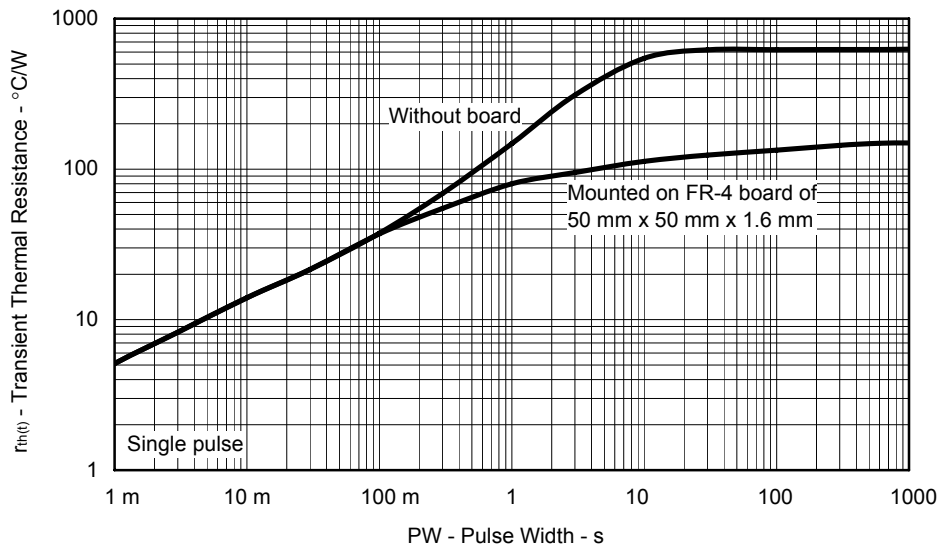
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



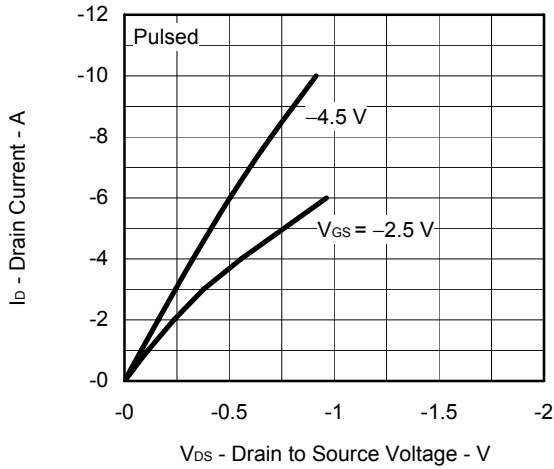
FORWARD BIAS SAFE OPERATING AREA



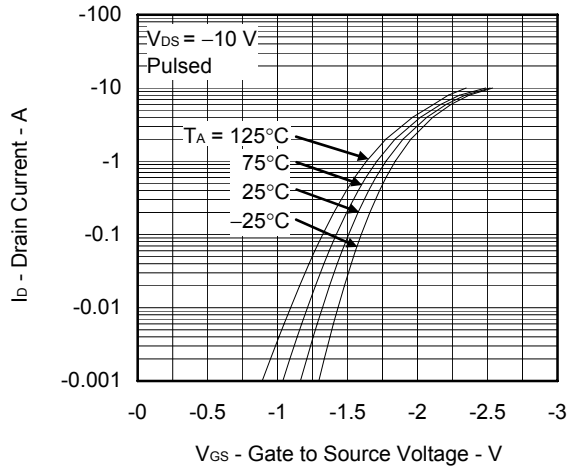
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



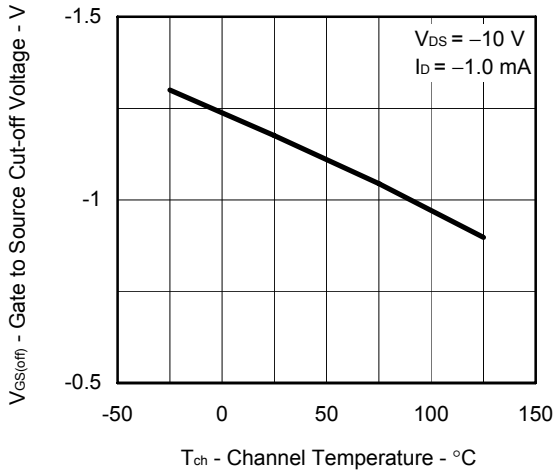
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



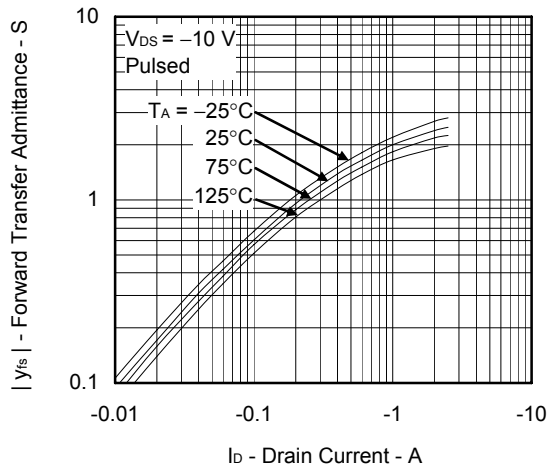
FORWARD TRANSFER CHARACTERISTICS



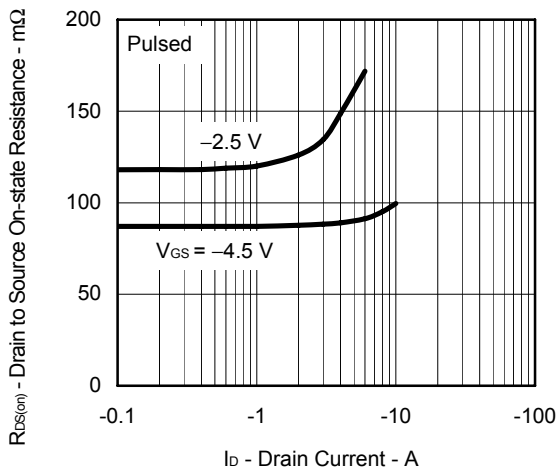
GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



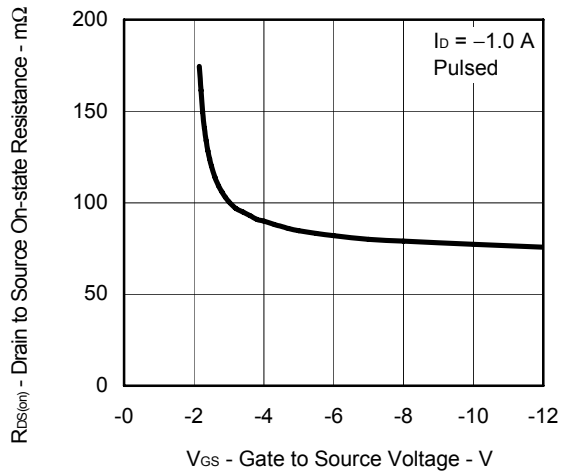
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



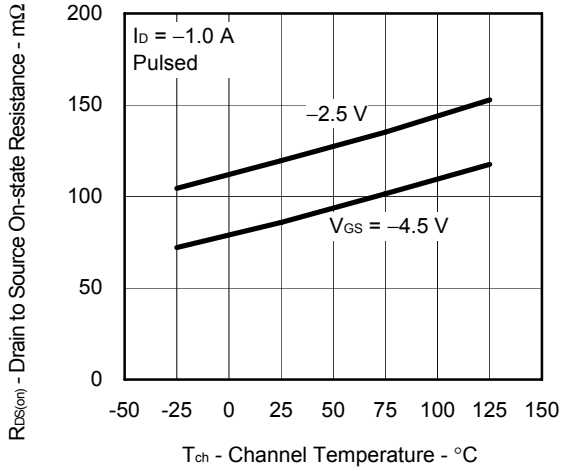
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



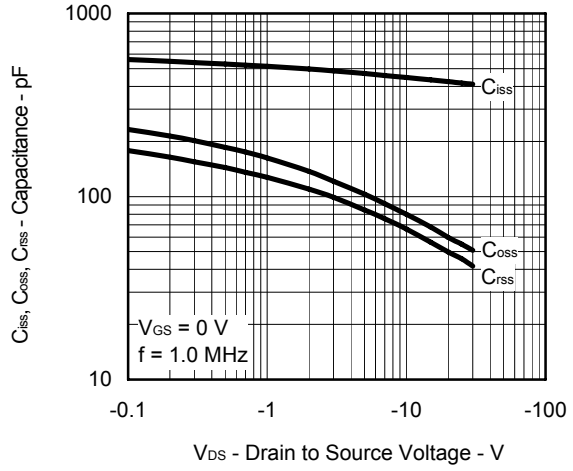
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



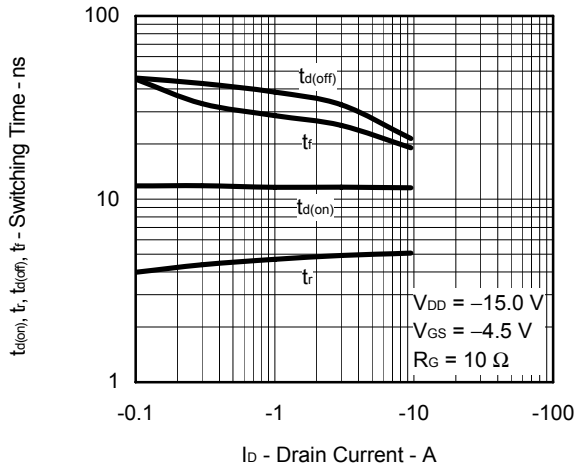
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



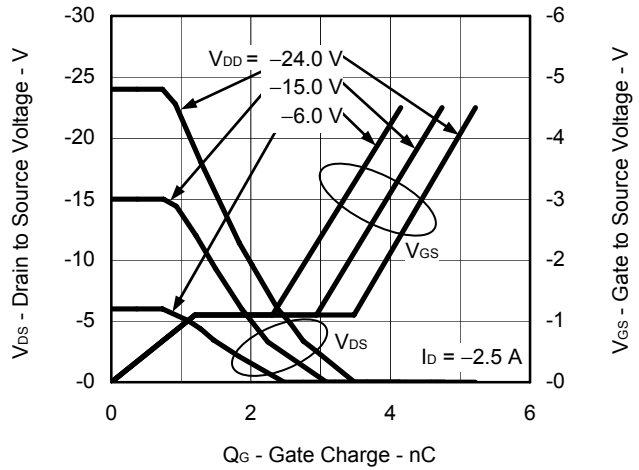
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



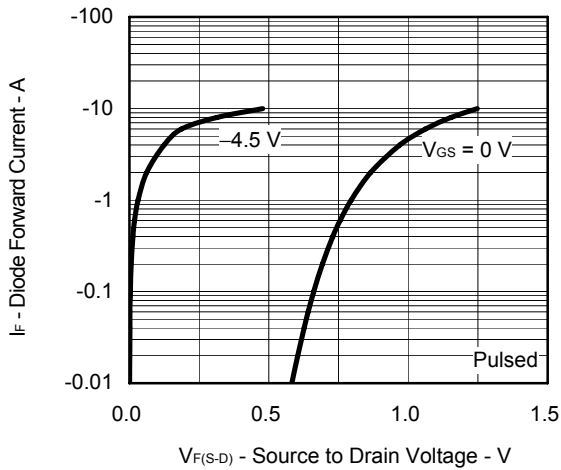
SWITCHING CHARACTERISTICS



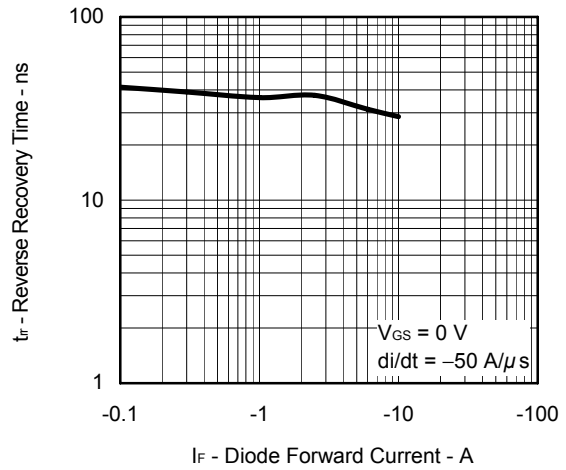
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE



REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



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